the Un. d States Patent and Traderak Office

the Application of , et al.

TI-24521

Serial No.: 09/732,468

Art Unit: 1765

December 7, 2000 Filed:

Examiner: V. Perez-Ramos

Method for Unpatterned Resist Etch Back of Shallow Title:

Trench Isolation Refill Insulator

March 20, 2002

Assistant Commissioner for Patents Washington, D. C. 20231

ING CERTIFICATE UNDER 37 C.F.R. \$1.8(A) ereby certify that the above correspondence is deposited with the U.S. Postal Service as Mail in an envelope addressed to: Assistant missioner for Patents, March 20, 2002. Washington, D.C

Washir	ngton, D. C. 2	0231	Lawrence	J. Bassuk, Reg. I	10. 29,0431 No. 29,0431	E A
Dear S	Sir:					
Transm	nitted herewit	h is an	amendment in	this appli	ication.	MAN
The fe	ee has been ca	lculated	as shown bel	.OW.	•	Cylon
		CL	AIMS AS AMEND	ED		00
	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NUMBER PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDITIONAL FEE
Total Claims	21	Minus	21	= 0	x \$18 =	\$ 0
Ind. Claims	1	Minus	3	= 0	x \$84 =	\$ 0
			TOTAL	ADDITIONAL TH	L FEE FOR	\$ 0

Under 37 C.F.R. § 1.16(k) please charge the total additional fee, and any further fees, or credit overpayment to Deposit Account of Texas Instruments Incorporated, No. 20-0668

Texas Instruments Incorporated P.O. Box 655474, M/S 3999 Dallas, Texas 75265 (972) 917-5458

Reg. No. 29,043

Attorney for Applicants

pectfully submitted,

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

#6 Ja 3/29/02

Bowles, et al.

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Serial No.: 09/732,468

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Title: Method for Unpatterned Resist Etch Back of Shallow

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Response under 37 CFR 1.111

March 20, 2002

Assistant Commissioner of Patents Washington, DC 20231

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A) I hereby certify that this correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231 on March 20, 4002

awrence J. Bassuk, Reg. No. 29,043

Dear Sir:

Applicants respond to the Office communication dated December 20, 2001 as follows:

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TC 1700